MOSFETs Silicon P-Channel MOS (U-MOSVI)

TPCA8120

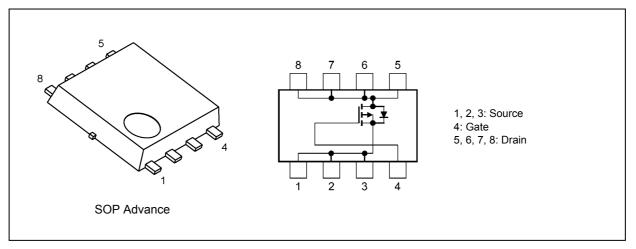
1. Applications

- Lithium-Ion Secondary Batteries
- Power Management Switches

2. Features

- (1) Small footprint due to a small and thin package
- (2) Low drain-source on-resistance: $R_{DS(ON)} = 2.4 \text{ m}\Omega$ (typ.) ($V_{GS} = -10 \text{ V}$)
- (3) Low leakage current: I_{DSS} = -10 μ A (max) (V_{DS} = -30 V)
- (4) Enhancement mode: V_{th} = -0.8 to -2.0 V (V_{DS} = -10 V, I_D = -1 mA)

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) ($T_a = 25 \degree$ C unless otherwise specified)

Characteristics				Rating	Unit
Drain-source voltage			V _{DSS}	-30	V
Gate-source voltage			V _{GSS}	-25/+20	
Drain current (DC)		(Note 1)	I _D	-45	A
Drain current (pulsed)		(Note 1)	I _{DP}	-135	
Power dissipation	(T _c = 25 °C)		PD	45	W
Power dissipation	(t = 10 s)	(Note 2)	PD	2.8	w
Power dissipation	(t = 10 s)	(Note 3)	PD	1.6	w
Single-pulse avalanche energy		(Note 4)	E _{AS}	263	mJ
Avalanche current			I _{AR}	-45	A
Channel temperature			T _{ch}	150	°C
Storage temperature			T _{stg}	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

5. Thermal Characteristics

Characteristics				Max	Unit
Channel-to-case thermal resistance	(T _c = 25 °C)		R _{th(ch-c)}	2.78	°C/W
Channel-to-ambient thermal resistance	(t = 10 s)	(Note 2)	R _{th(ch-a)}	44.6	°C/W
Channel-to-ambient thermal resistance	(t = 10 s)	(Note 3)	R _{th(ch-a)}	78.1	°C/W

Note 1: Ensure that the channel temperature does not exceed 150 °C.

Note 2: Device mounted on a glass-epoxy board (a), Figure 5.1

Note 3: Device mounted on a glass-epoxy board (b), Figure 5.2

Note 4: V_{DD} = -24 V, T_{ch} = 25 °C (initial), L = 0.1 mH, R_G = 25 Ω , I_{AR} = -45 A

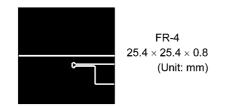


Fig. 5.1 Device Mounted on a Glass-Epoxy Board (a)

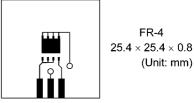


Fig. 5.2 Device Mounted on a Glass-Epoxy Board (b)

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

6. Electrical Characteristics

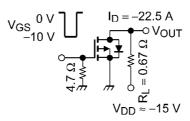
6.1. Static Characteristics (T_a = 25 $^{\circ}$ C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I _{GSS}	V_{GS} = ±20 V, V_{DS} = 0 V	_		±0.1	μA
Drain cut-off current	I _{DSS}	V _{DS} = -30 V, V _{GS} = 0 V	_		-10	
Drain-source breakdown voltage	V _{(BR)DSS}	I _D = -10 mA, V _{GS} = 0 V	-30		_	V
Drain-source breakdown voltage (Note 5)	V _{(BR)DSX}	I _D = -10 mA, V _{GS} = 10 V	-21		_	
Gate threshold voltage	V _{th}	V _{DS} = -10 V, I _D = -1 mA	-0.8		-2.0	
Drain-source on-resistance	R _{DS(ON)}	V _{GS} = -4.5 V, I _D = -22.5 A	_	3.1	4.0	mΩ
		V _{GS} = -10 V, I _D = -22.5 A	_	2.4	3.0	

Note 5: If a forward bias is applied between gate and source, this device enters V_{(BR)DSX} mode. Note that the drainsource breakdown voltage is lowered in this mode.

6.2. Dynamic Characteristics ($T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz		7420	_	pF
Reverse transfer capacitance	C _{rss}]		1180	_	
Output capacitance	C _{oss}			1440	_	
Switching time (rise time)	tr	See Fig. 6.2.1.		10	_	ns
Switching time (turn-on time)	t _{on}]		18	_	
Switching time (fall time)	t _f]		262	_	
Switching time (turn-off time)	t _{off}]		762	_	



 $Duty \leq 1\%, \, t_W = 10 \; \mu s$ Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics (Ta = 25 °C unless otherwise specified)

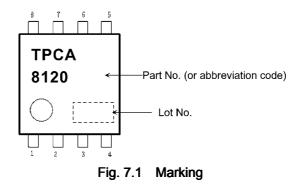
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Qg	$V_{DD} \approx$ -24 V, V_{GS} = -10 V, I_D = -45 A	_	190	—	nC
Gate-source charge 1	Q _{gs1}		_	23	_	
Gate-drain charge	Q _{gd}			47	_	

6.4. Source-Drain Characteristics (T_a = 25 °C unless otherwise specified)

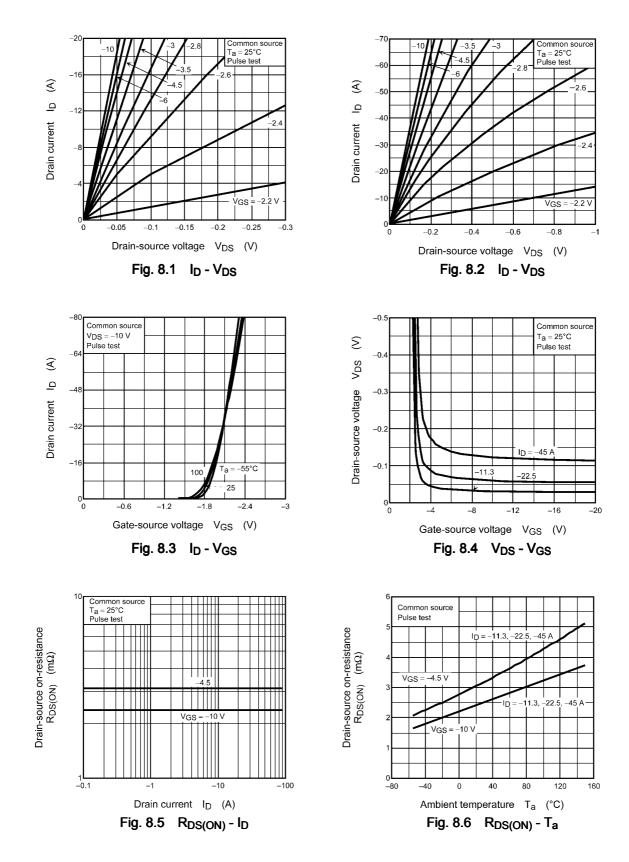
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (pulsed) (No	te 6) I _{DRP}	—	_	_	-135	Α
Diode forward voltage	V _{DSF}	I _{DR} = -45 A, V _{GS} = 0 V		_	1.2	V

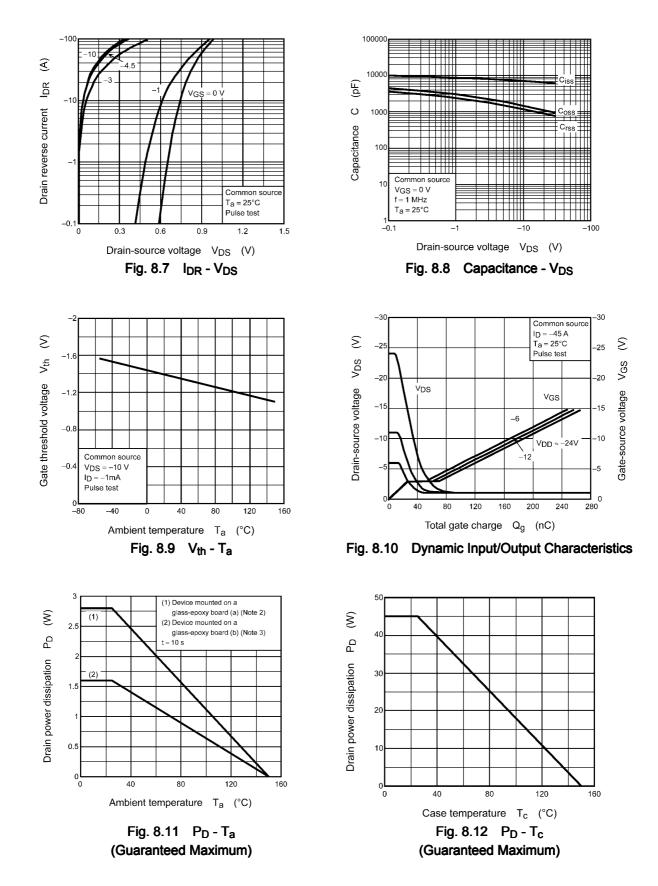
Note 6: Ensure that the channel temperature does not exceed 150 °C.

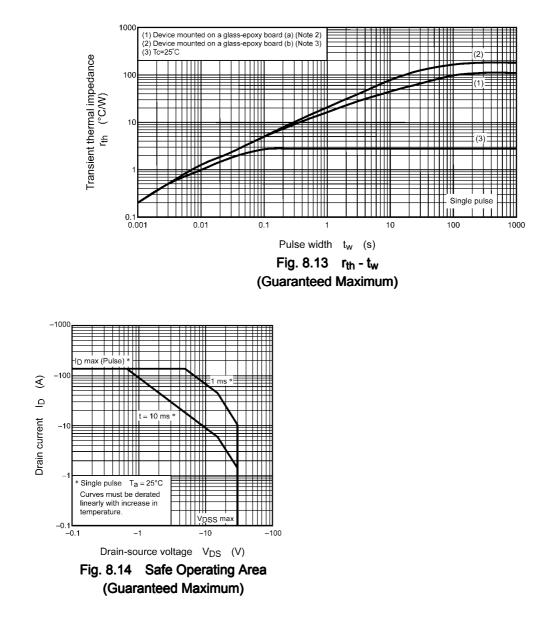
7. Marking



8. Characteristics Curves (Note)







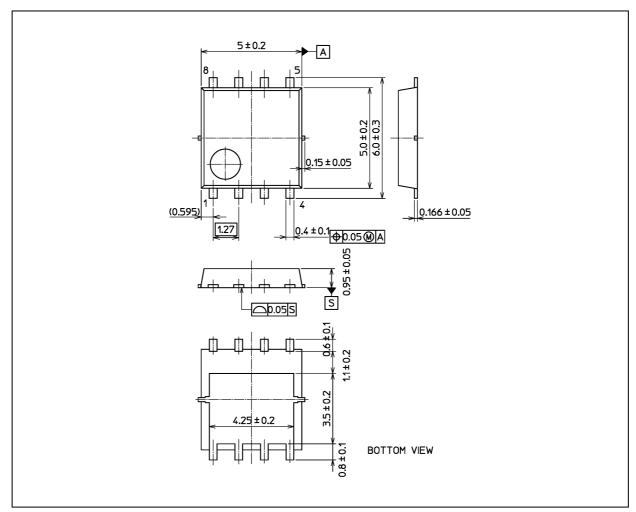
Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



TPCA8120

Package Dimensions

Unit: mm



Weight: 0.069 g (typ.)

TOSHIBA: 2-5Q1S

Nickname: SOP Advance

Package Name(s)

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